

Announcement

INTERNATIONAL SOCIETY FOR HYBRID MICROELECTRONICS

The International Society for Hybrid Micro-electronics is based in the U.S.A., and there are independent parallel organisations throughout the world. These groups are independent, non-profit-making organisations, the purpose of which is to provide an informal means of discussing and advancing hybrid technology. This is achieved by the organisation of meetings, the publication of a Newsletter and other activities as appropriate. Membership is open to all and there are no formal entry requirements.

All these societies run a programme of meetings throughout the year on subjects concerned with thick films, and interested readers are advised to contact the following Chairmen for details of meetings in their own areas:

1. Benelux

Mr G. K. Steenvoorden
Technische Hogeschool Delft
Lorentzweg 1
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2. France

Dr B. Dreyfus-Alain
President de I.F.M.H.
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3. Germany

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Chairman I.S.H.M. Deutschland
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4. Italy

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5. Japan

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6. Nordic

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7. U.K.

Dr J. T. Law
Bio-engineering Unit
Princess Margaret Rose Hospital
Fairmile Head
EDINBURGH
Scotland
Great Britain

8. U.S.A. — all U.S. Chapters

I.S.H.M.
P.O. Box 3255
MONTGOMERY
Alabama 36109, U.S.A.

In addition, the European Chapters are all linked together through the European Liason Committee, Chairman:

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Kardinal Mercierlaan 94
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